



Application No. 09/955,722
SD-6436.1 S-97675

GP 2815

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Application No. **09/955,722**
Applicant: **Peterson**
Title: **Temporary Coating for Protection of Microelectronic Devices
During Packaging**
Filing Date: **09/18/2001**
Art Unit **2815**
Examiner **Eugene Lee**
Docket No.: **SD-6436.1 S-97675**

Assistant Commissioner for Patents
Box Non-Fee Amendment
Washington DC 20231

January 30, 2003

AMENDMENT

Dear Sir:

In response to the First Office Action of 10/23/2002, please amend the above-identified application and reconsider the patentability of the invention in light of the arguments and amendments presented herein. Applicants submit the following in complete response thereto.

The office is authorized to charge deposit account **Deposit Account # 19-0131** for any necessary fees regarding this Amendment.

Applicants wish to call attention to the issuance of the parent application, 09/572,562, which issued as US Patent 6,335,224, on Jan. 1, 2002, "Protection of Microelectronic Devices During Packaging", by Peterson and Conley. A copy is appended hereto.

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01 FC:1201 110.00 CH
02 TC:1202 72.00